

General Description

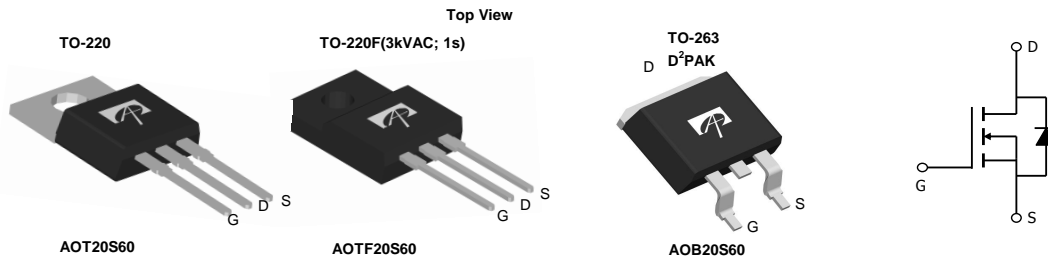
The AOT20S60 & AOB20S60 & AOTF20S60 have been fabricated using the advanced α MOS™ high voltage process that is designed to deliver high levels of performance and robustness in switching applications. By providing low $R_{DS(on)}$, Q_g and E_{oss} along with guaranteed avalanche capability these parts can be adopted quickly into new and existing offline power supply designs.

For Halogen Free add "L" suffix to part number:
 AOT20S60L & AOB20S60L & AOTF20S60L

Product Summary

$V_{DS} @ T_{j,max}$	700V
I_{DM}	80A
$R_{DS(ON),max}$	0.199 Ω
$Q_{g,typ}$	20nC
$E_{oss} @ 400V$	4.9 μ J

100% UIS Tested
 100% R_g Tested


Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	AOT20S60/AOB20S60	AOTF20S60	AOTF20S60L	Units	
Drain-Source Voltage	V_{DS}	600			V	
Gate-Source Voltage	V_{GS}	± 30			V	
Continuous Drain Current	I_D	$T_C=25^\circ\text{C}$	20	20*	A	
		$T_C=100^\circ\text{C}$	14	14*		
Pulsed Drain Current ^C	I_{DM}	80				
Avalanche Current ^C	I_{AR}	3.4			A	
Repetitive avalanche energy ^C	E_{AR}	23			mJ	
Single pulsed avalanche energy ^G	E_{AS}	188			mJ	
Power Dissipation ^B	P_D	$T_C=25^\circ\text{C}$	266	50	37.8	W
		Derate above 25°C	2.1	0.4	0.3	W/ $^\circ\text{C}$
MOSFET dv/dt ruggedness	dv/dt	100			V/ns	
Peak diode recovery dv/dt ^H		20				
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150			$^\circ\text{C}$	
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds ^J	T_L	300			$^\circ\text{C}$	

Thermal Characteristics

Parameter	Symbol	AOT20S60/AOB20S60	AOTF20S60	AOTF20S60L	Units
Maximum Junction-to-Ambient ^{A,D}	$R_{\theta JA}$	65	65	65	$^\circ\text{C}/\text{W}$
Maximum Case-to-sink ^A	$R_{\theta CS}$	0.5	--	--	$^\circ\text{C}/\text{W}$
Maximum Junction-to-Case	$R_{\theta JC}$	0.47	2.5	3.3	$^\circ\text{C}/\text{W}$

* Drain current limited by maximum junction temperature.

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V, T _J =25°C	600	-	-	V
		I _D =250μA, V _{GS} =0V, T _J =150°C	650	700	-	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =600V, V _{GS} =0V	-	-	1	μA
		V _{DS} =480V, T _J =150°C	-	10	-	
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±30V	-	-	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =5V, I _D =250μA	2.8	3.4	4.1	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =10A, T _J =25°C	-	0.18	0.199	Ω
		V _{GS} =10V, I _D =10A, T _J =150°C	-	0.48	0.53	Ω
V _{SD}	Diode Forward Voltage	I _S =10A, V _{GS} =0V, T _J =25°C	-	0.84	-	V
I _S	Maximum Body-Diode Continuous Current		-	-	20	A
I _{SM}	Maximum Body-Diode Pulsed Current ^C		-	-	80	A
DYNAMIC PARAMETERS						
C _{ISS}	Input Capacitance	V _{GS} =0V, V _{DS} =100V, f=1MHz	-	1038	-	pF
C _{OSS}	Output Capacitance		-	68	-	pF
C _{o(er)}	Effective output capacitance, energy related ^H	V _{GS} =0V, V _{DS} =0 to 480V, f=1MHz	-	56.6	-	pF
C _{o(tr)}	Effective output capacitance, time related ^I		-	176.5	-	pF
C _{rSS}	Reverse Transfer Capacitance	V _{GS} =0V, V _{DS} =100V, f=1MHz	-	2.1	-	pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	-	9.3	-	Ω
SWITCHING PARAMETERS						
Q _g	Total Gate Charge	V _{GS} =10V, V _{DS} =480V, I _D =10A	-	19.8	-	nC
Q _{gs}	Gate Source Charge		-	4.6	-	nC
Q _{gd}	Gate Drain Charge		-	7.6	-	nC
t _{D(on)}	Turn-On Delay Time	V _{GS} =10V, V _{DS} =400V, I _D =10A, R _G =25Ω	-	27.5	-	ns
t _r	Turn-On Rise Time		-	32	-	ns
t _{D(off)}	Turn-Off Delay Time		-	87.5	-	ns
t _f	Turn-Off Fall Time		-	30	-	ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =10A, dI/dt=100A/μs, V _{DS} =400V	-	350	-	ns
I _{rm}	Peak Reverse Recovery Current	I _F =10A, dI/dt=100A/μs, V _{DS} =400V	-	27	-	A
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =10A, dI/dt=100A/μs, V _{DS} =400V	-	5.7	-	μC

A. The value of R_{θJA} is measured with the device in a still air environment with T_A=25°C.

B. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C. Ratings are based on low frequency and duty cycles to keep initial T_J=25°C.

D. The R_{θJA} is the sum of the thermal impedance from junction to case R_{θJC} and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)}=150°C. The SOA curve provides a single pulse rating.

G. L=60mH, I_{AS}=2.5A, V_{DD}=150V, Starting T_J=25°C

H. C_{o(er)} is a fixed capacitance that gives the same stored energy as C_{OSS} while V_{DS} is rising from 0 to 80% V_{(BR)DSS}.

I. C_{o(tr)} is a fixed capacitance that gives the same charging time as C_{OSS} while V_{DS} is rising from 0 to 80% V_{(BR)DSS}.

J. Wavesoldering only allowed at leads.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

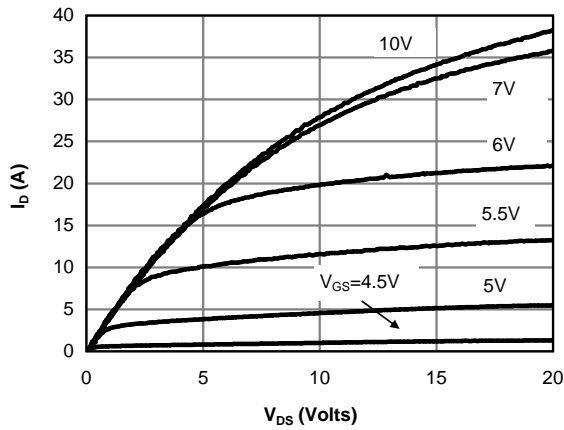


Figure 1: On-Region Characteristics @ 25°C

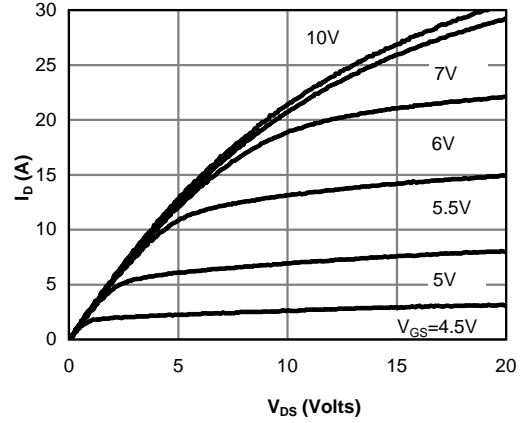


Figure 2: On-Region Characteristics @ 125°C

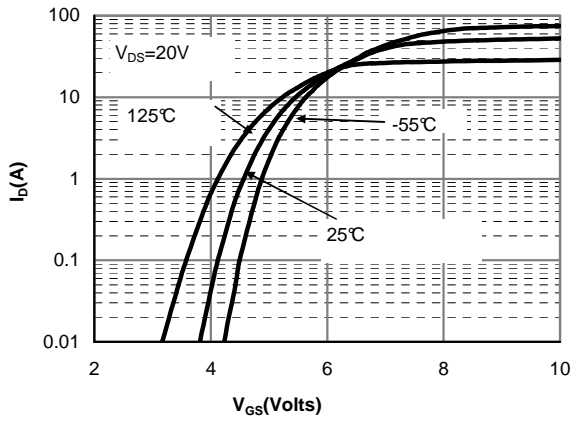


Figure 3: Transfer Characteristics

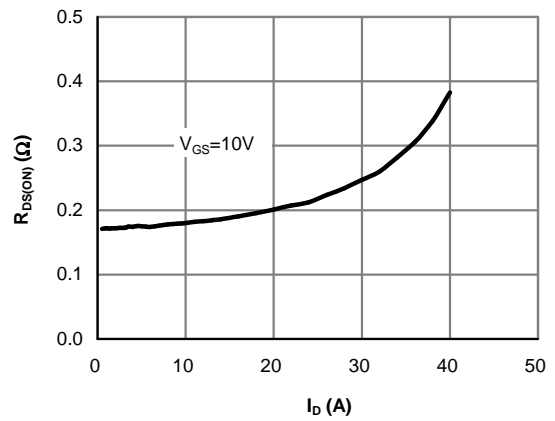


Figure 4: On-Resistance vs. Drain Current and Gate Voltage

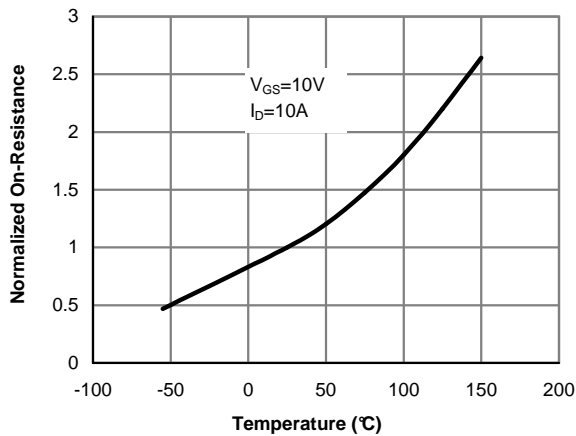


Figure 5: On-Resistance vs. Junction Temperature

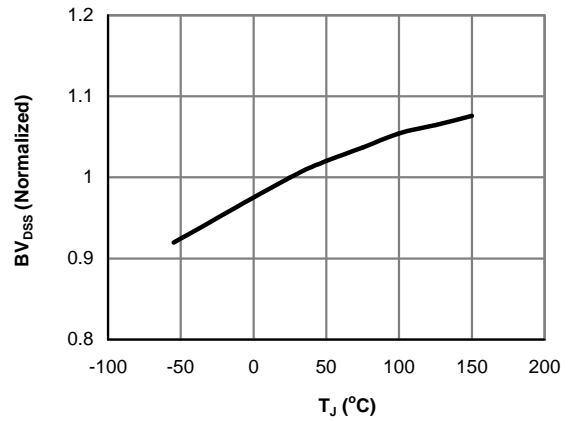


Figure 6: Break Down vs. Junction Temperature

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

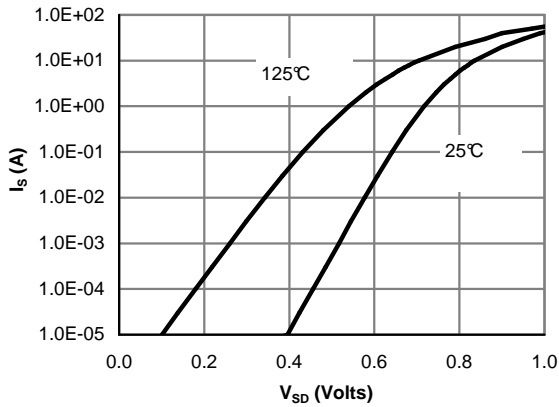


Figure 7: Body-Diode Characteristics (Note E)

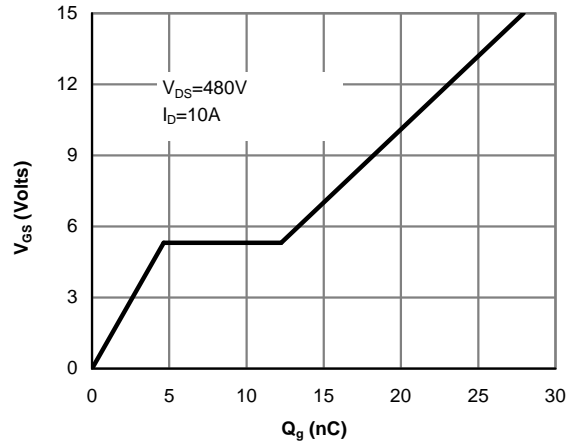


Figure 8: Gate-Charge Characteristics

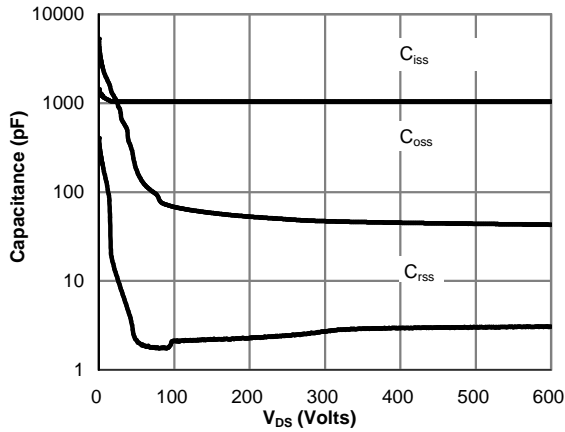


Figure 9: Capacitance Characteristics

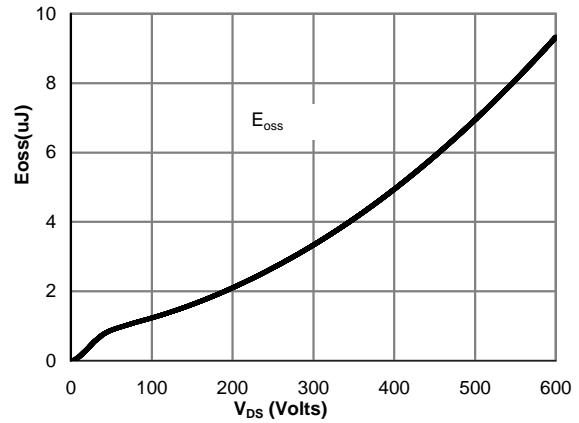


Figure 10: Coss stored Energy

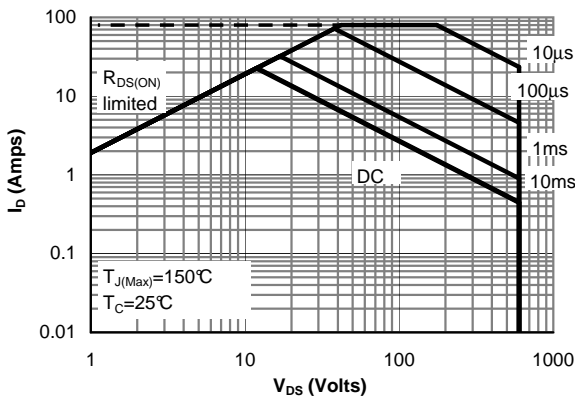


Figure 11: Maximum Forward Biased Safe Operating Area for AOT(B)20S60 (Note F)

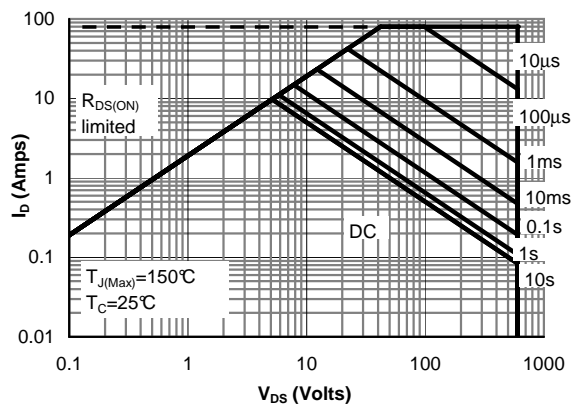


Figure 12: Maximum Forward Biased Safe Operating Area for AOTF20S60 (Note F)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

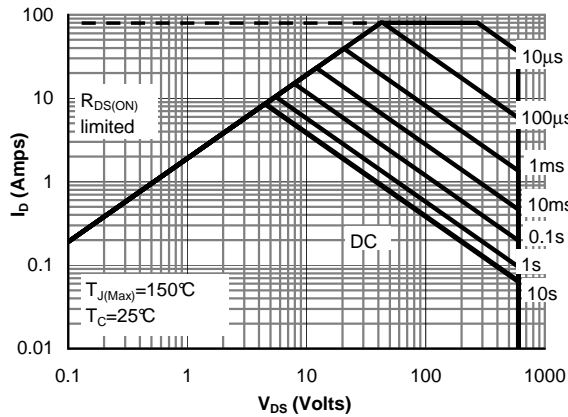


Figure 13: Maximum Forward Biased Safe Operating Area for AOTF20S60L(Note F)

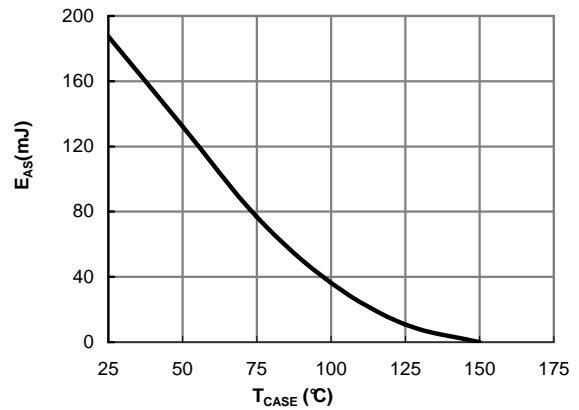


Figure 14: Avalanche energy

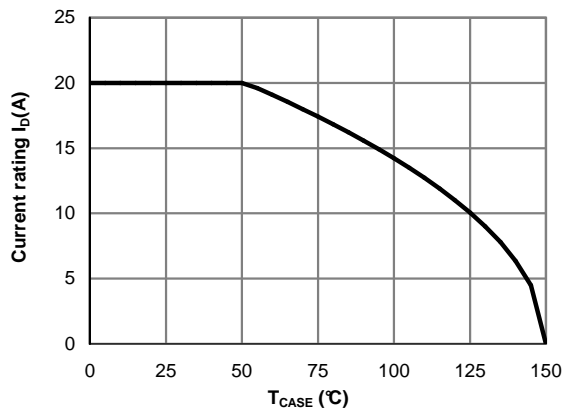


Figure 15: Current De-rating (Note B)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

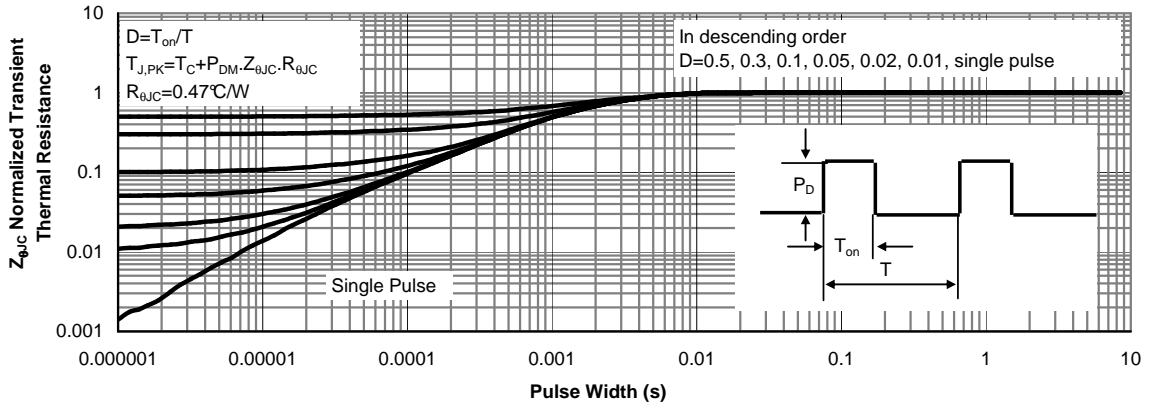


Figure 16: Normalized Maximum Transient Thermal Impedance for AOT(B)20S60 (Note F)

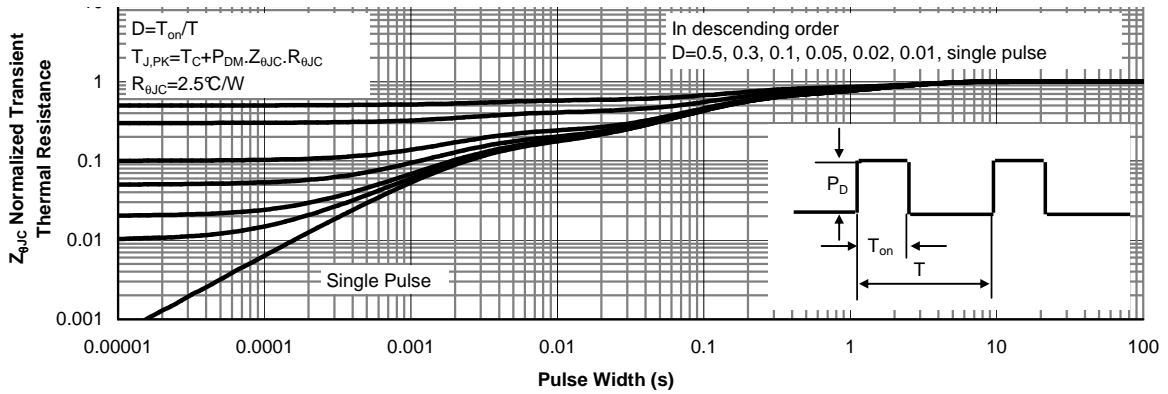


Figure 17: Normalized Maximum Transient Thermal Impedance for AOTF20S60 (Note F)

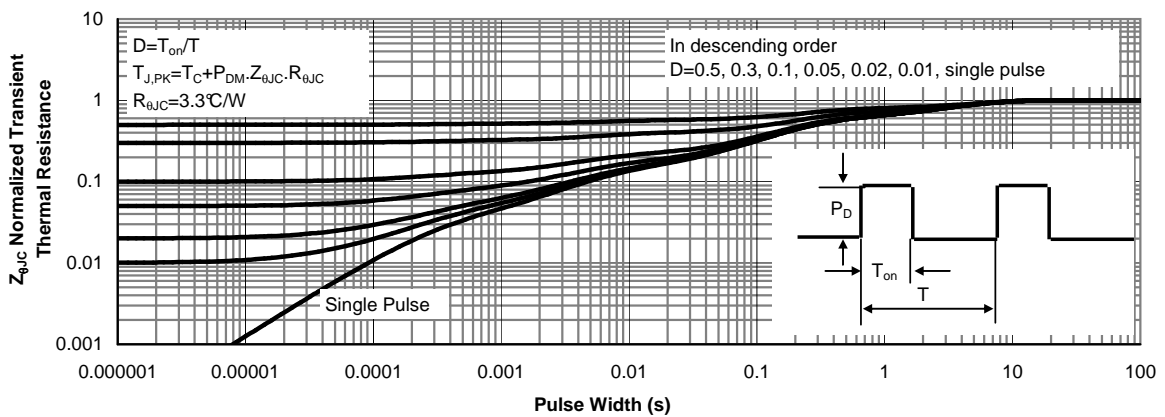
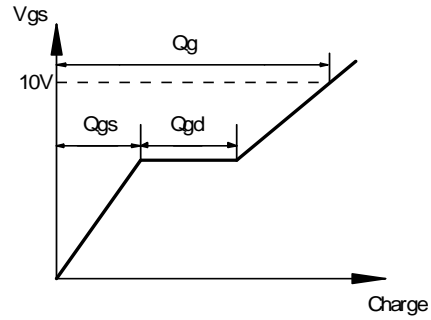
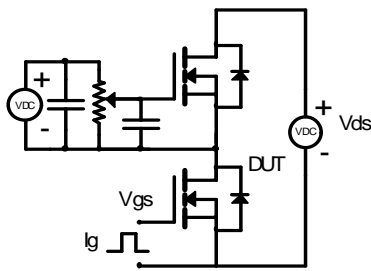
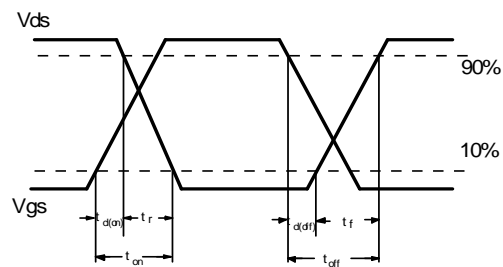
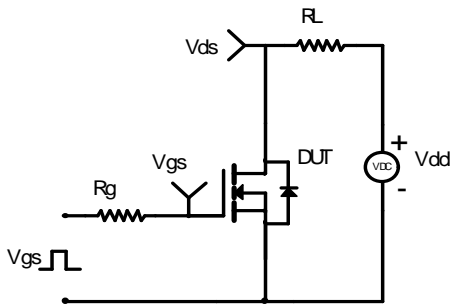


Figure 18: Normalized Maximum Transient Thermal Impedance for AOTF20S60L (Note F)

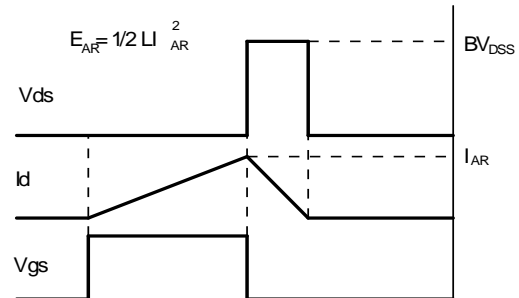
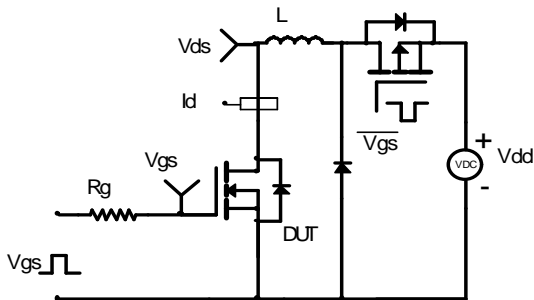
Gate Charge Test Circuit & Waveform



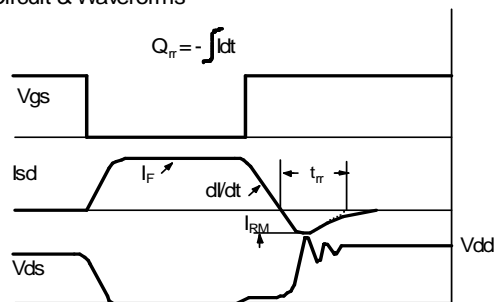
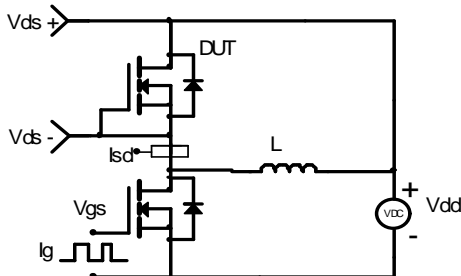
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